DATE:

APPROVAL SPECIFICATION

PRODUCT NAME: SMD power inductor

YOUR PART NO. :

OUR PART NO.: MPIT6028-series

RECEPTION					
THE SPECIFICAT	TION HAS BEEN ACCEP	TED.			
COMBANN	DATE	:			
COMPANY:					
		Γ			
CFMD	CHKD	RCVD			

MANUFACTURING NAME

深圳市麦捷微电子科技股份有限公司 SHENZHEN MICROGATE TECHNOLOGY CO., LTD Address: Yuxing road, Golf Street, Guanlan Town Bao' an District Shenzhen P.R.C Postcode :518110 TEL: 86-755-28085000 FAX: 86-755-28085605

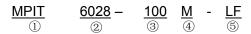
CFMD.	CHKD.	DSGD.
胡潞乐	王玉生	刘维

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1. Scope

This specification applies to the MPIT series of SMD power inductors.

2. Product Identification



① Series name

2 Product dimensions

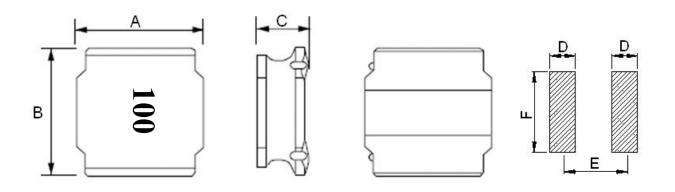
③ Inductance Value: (6R3:6.3uH 100: 10uH; 101:100uH)

④ Inductance Tolerance: (K:10%; M:20%; N:30%)

5 Lead free products

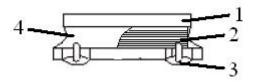
3. Construction

3.1 Shape and dimensions



		Dime	ensions in mn	n		
Model	A	В	С	D	Е	F
MPIT6028	6.0±0.3	6.0±0.3	3.0 Max.	1.6 ref.	4.7 ref.	5.7 ref.

3.2 Material List



No.	Item	Material
1	DR Core	Ferrite
2	Wire	Enameled Copper Wire
3	Solder	Sn99.7-Cu0.3
4	Ероху	Epoxy Adhesive

Postcode: 518110

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4.Testing Conditions

Unless otherwise specified $(5 \text{ to } 35^{\circ}\text{C})$ Temperature : Ordinary Temperature $(5 \text{ to } 35^{\circ}\text{C})$ Humidity : Ordinary Humidity(25 to 85% RH)Atmospheric Pressure : 86 to 106 kPa

In case of doubt Temperature : 20±2°C Humidity : 60 to 75% RH Atmospheric Pressure : 86 to 106 kPa

5. Electrical Characteristics And Test Instruments

Operating temperature:- $40 \sim 85^{\circ}$ C Storage temperature and Humidity Range: - $40 \sim 125^{\circ}$ C & 30% to 70%

Microgate Part No.	Customer Part No.	Inductance (uH)	DCR (mΩ)max	Isat (A) max	Irms (A) max
MPIT6028-0R9N-LF		0.9±30%	16.9	6.6	4.6
MPIT6028-1R5N-LF		1.5±30%	20.8	5.0	4.2
MPIT6028-2R2N-LF		2.2±30%	26	4.2	3.7
MPIT6028-3R0N-LF		3.0±30%	29.9	3.6	3.4
MPIT6028-4R7M-LF		4.7±20%	40.3	2.7	3.0
MPIT6028-6R8M-LF		6.8±20%	54.7	2.2	2.5
MPIT6028-100M-LF		10±20%	84.5	1.9	1.9
MPIT6028-150M-LF		15±20%	123.5	1.6	1.8
MPIT6028-220M-LF		22±20%	175.5	1.3	1.4
MPIT6028-330M-LF		33±20%	286	1.1	1.1
MPIT6028-470M-LF		47±20%	390	0.95	0.92
MPIT6028-680M-LF		68±20%	546	0.76	0.77
MPIT6028-101M-LF		100±20%	780	0.62	0.66

* CHROMA 3302 meter for L adn DCR.

* CHROMA 3302 and 1320 meter for IDC.

* L test condition: 100KHz/1V.

* IDC: $|L0A-L3.0A|/L0A \le 30\%$ and temperature rise: Irms = 2.5A $\Delta T \le 40^{\circ}C$ The part must be allowed high temperature : $125^{\circ}C$

6. Reliability and Test Condition

Item	Specifications	Test Method/Condition		
Operating temperature range	–25 ℃ ~ +85℃	Including tempeature rise due to self-generated heat		
Terminal strength-pull test	Terminal shall not be loosened or ruptured	A 5N. load shall be applied to both terminals in the axis direction for 60 sec.		
Solderability test	The terminal shall be at least 90% covered with solder.	After fluxing, Inductor shall be dipped in a melted solder bath at 230 ± 5 °C for 5 seconds.		
Resistance to solvent test	There shall be no case deformation change in appearance obliteration of marking.	MIL-STD-105E II		
Vibration test (low frequency)	1.Inductors shall be no evidence of	1.Amplitude:1.5mm. 2.Frequency:10~55~10Hz/min. 3.Direction:X.Y.Z. 4.Duration:2 hrs/X.Y.Z.		
Shock test	electrical and mechanical damage. 2.Inductance shall not chance more than=5%.	Inductors shall be dropped 10from a height of 1m onto 3cm wooden board.		
Resistance to soldering heat	3.Q shall not change more than=20%	Temp:260±5℃,Time:10±1sec		
High temperature load life test	There shall be no evidence of	1. temp:85±2℃. 2. time: 1000±12 hours. 3. load: allowed DC current.		
Humidity load life	Short or open circuiting.	 temp: 40±2℃. R.H: 90-95%. time: 1000±12 hours. load: allowed DC current. 		

Item	Required Characteristics	Test Method/Condition				
Temperature characteristic	 Inductors shall be no evidence of electrical and mechanical danage Inductance shall not change more than±5%. 	–25°C ~ +85°C				
Humidity test		1. Temp:40±2℃. 2. R.H:90-95%. 3. Time:96±2 hours.				
Cold test		1. Temp:-40±2℃. 2. Time:96±2 hours.				
Thermal shock test	3. Q shall not change more than ±30%.	room temp – 40±2°C 15mins 30mins room temp 85±2°C 15mins 30mins total:5				
Dry heat test		1. temp:85±2℃ 2. time: 96±2 hours				

7. Recommended Soldering Conditions

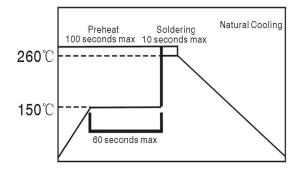
Product can be applied to flow and reflow soldering.

(1) Flux, Solder

(1) Use rosin-based flux. Don't use highly acidic flux with halide content exceeding 0.2wt% (chlorine conversion value).

⁽²⁾ Use Sn solder.

- (2) Flow soldering conditions
 - ① Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150°C max. Cooling into solvent after soldering also should be in such a way that temperature difference is limited to 100°C max. Unwrought pre-heating may cause cracks on the product, resulting in the deterioration of products quality.
 - ② Standard soldering profile.



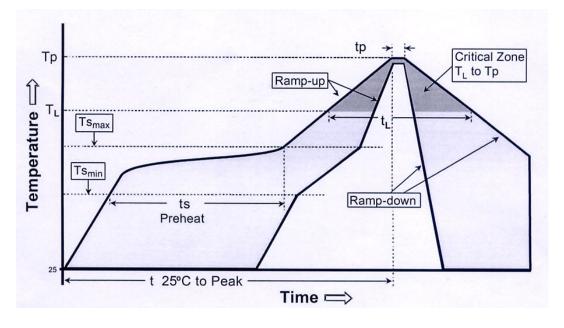
Pre-heating	150°C,1 minute min
Peak	260°C,10 seconds max

(3)Reflow soldering conditions

	Profile Feature	Lead-Free Assembly	
Average Ram	p-Up Rate (Ts max. to Tp)	3° C /second max.	
	- Temperature Min (Ts min.)	150 °C	
Preheat	– Temperature Max (Ts max.)	200 °C	
	– Time (ts min to ts max.)	60-180 seconds	
Time maintained	– Temperature (TL) 217 °C		
above	– Time (tL)	60-150 seconds	
Peak/Class	sification Temperature (Tp)	260 °C	
Peak/C	Classification Time (Tp)	3-4 seconds	
Time wi	ithin 5 °C of actual Peak	20.40	
,	Temperature (tp)	20-40 seconds	
F	Ramp-Down Rate	6°C/second max.	
Time 25	°C to Peak Temperature	8 minutes max.	

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

Reflow curve



(4) The method on Re-work with using the iron:

The following conditions must be strictly followed when using a soldering iron

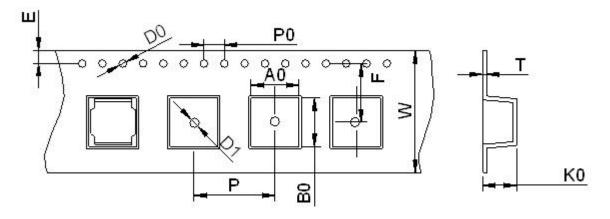
Pre-heating	150°C, 1 minute
Tip temperature	280°C max
Soldering iron output	20w max
End of soldering iron	ф1mm max
Soldering time	3 seconds max

8. Cleaning Conditions

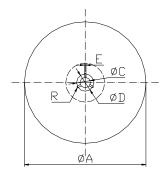
Products shall be cleaned on the following conditions.

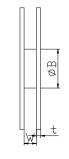
- (1) Cleaning temperature shall be limited to 60° C max.(40° C max for fluoride and alcohol type cleaner.)
- (2) Ultrasonic cleaning shall comply with the following conditions with avoiding the resonance phenomenon at the mounted products and P.C.B.
 - Power : 20W/t max Frequency: below 40 kHz Time : 5 minutes max
- (3) Cleaner
 - a) Alternative cleaner Isopropyl alcohol (IPA)
 - Isopropyl alcohol (IPA) b) Aqueous agent Surface Active Agent Type (CLEANTHROUGH 750H) Hydrocarbon Type (TECHNOCLEANER 335) Higher Alcohol Type (PINE ALPHA ST-100S) Alkali Saponification Type (*AQUACLEANER 240)
- (4) Thee shall be no residual flux and residual cleaner after cleaning. In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.
- (5) Other cleaning Please contact us.

9. Package Information (Unit: mm)



-				4.80±0.10		1.75±0.10	7.5±0.10	12.0±0.10				0.35±0.05
	W	A0	B0	K0	K1	E	F	P	P0	D0	D1	T



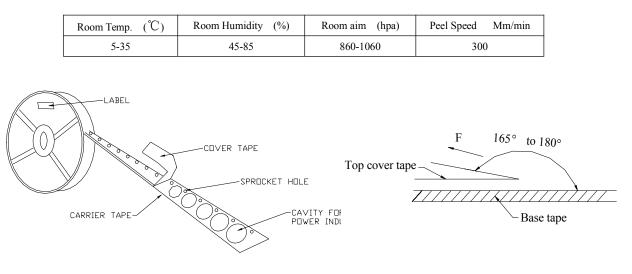


А	330±2.0
В	100±2.0
С	13.5±0.5
D	21±0.5
Е	2.2
R	R1.0
W	16.5
t	2.5

Packing quantity: 2000pcs/rell

9.1 Peeling strength of cover tape:

The force tearing off cover tape is 30 to60 grams in the arrow direction under the following conditions.



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10. Products Storage

(1) Storage period

Products which inspected in MICROGATE over 6 months ago should be examined and used, which can be confirmed with inspection No. marked on the container. Solderability should be checked if this period is exceeded.

(2) Storage conditions

Products should be storage in the warehouse on the following conditions:

Temperature: -10 ~+ 40 °C

Humidity : Less than 80% relative and humidity

No rapid change on temperature and humidity

- (3) Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
- (4) Products should be storage on the palette for the prevention of the influence from humidity, dust and so on.
- (5) Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- (6) Products should be storage under the airtight packaged condition.

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